

Philips Components

Data sheet	
status	Preliminary specification
date of issue	March 1991

BUK442-60A/B

PowerMOS transistor

PHILIPS INTERNATIONAL

56E D ■ 7110826 0044564 706 ■ PHIN

GENERAL DESCRIPTION

N-channel enhancement mode field-effect power transistor in a plastic full-pack envelope. The device is intended for use in Switched Mode Power Supplies (SMPS), motor control, welding, DC/DC and AC/DC converters, and in automotive and general purpose switching applications.

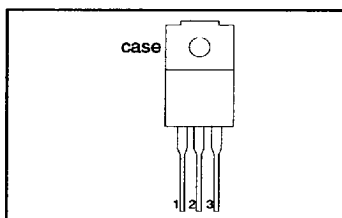
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	UNIT
	BUK442	-60A	-60B	
V_{DS}	Drain-source voltage	60	60	V
I_D	Drain current (DC)	10	9.2	A
P_{tot}	Total power dissipation	22	22	W
T_j	Junction temperature	150	150	°C
$R_{DS(ON)}$	Drain-source on-state resistance	0.13	0.15	Ω

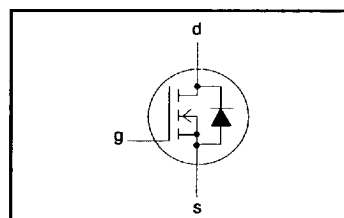
PINNING - SOT186

PIN	DESCRIPTION
1	gate
2	drain
3	source
case	isolated

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	Drain-source voltage	-	-	60	V
V_{DGR}	Drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	60	V
$\pm V_{GS}$	Gate-source voltage	-	-	30	V
I_D	Drain current (DC)	$T_{hs} = 25 \text{ }^\circ\text{C}$	-	-60A 10	A
I_D	Drain current (DC)	$T_{hs} = 100 \text{ }^\circ\text{C}$	-	6.3	A
I_{DM}	Drain current (pulse peak value)	$T_{hs} = 25 \text{ }^\circ\text{C}$	-	40	A
P_{tot}	Total power dissipation	$T_{hs} = 25 \text{ }^\circ\text{C}$	-	22	W
T_{sig}	Storage temperature	-	- 55	150	°C
T_j	Junction Temperature	-	-	150	°C

PowerMOS transistor**BUK442-60A/B**

PHILIPS INTERNATIONAL

56E D ■ 7110826 0044565 642 ■ PHIN

THERMAL RESISTANCES

From junction to heatsink From junction to ambient	with heatsink compound	$R_{th\ j-hs} = 5.68\text{ K/W}$ $R_{th\ j-a} = 55\text{ K/W}$
---	------------------------	---

STATIC CHARACTERISTICS $T_{hs} = 25\text{ °C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}; I_D = 0.25\text{ mA}$	60	-	-	V
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = 1\text{ mA}$	2.1	3.0	4.0	V
I_{OSS}	Zero gate voltage drain current	$V_{DS} = 60\text{ V}; V_{GS} = 0\text{ V}; T_J = 25\text{ °C}$	-	1	10	μA
I_{OSS}	Zero gate voltage drain current	$V_{DS} = 60\text{ V}; V_{GS} = 0\text{ V}; T_J = 125\text{ °C}$	-	0.1	1.0	mA
I_{GSS}	Gate source leakage current	$V_{GS} = \pm 30\text{ V}; V_{DS} = 0\text{ V}$	-	10	100	nA
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10\text{ V}; I_D = 8.5\text{ A}$	-	0.11	0.13	Ω
		BUK442-60A	-	0.13	0.15	Ω
		BUK442-60B	-	0.13	0.15	Ω

DYNAMIC CHARACTERISTICS $T_{hs} = 25\text{ °C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
g_{fs}	Forward transconductance	$V_{DS} = 25\text{ V}; I_D = 8.5\text{ A}$	3.5	4.7	-	S
C_{iss}	Input capacitance	$V_{GS} = 0\text{ V}; V_{DS} = 25\text{ V}; f = 1\text{ MHz}$	-	400	500	pF
C_{oss}	Output capacitance		-	150	200	pF
C_{rss}	Feedback capacitance		-	70	100	pF
t_{don}	Turn-on delay time	$V_{DD} = 30\text{ V}; I_D = 3\text{ A}; V_{GS} = 10\text{ V}; R_{GS} = 50\text{ }\Omega;$	-	8	14	ns
t_r	Turn-on rise time	$R_{gen} = 50\text{ }\Omega$	-	25	45	ns
t_{doff}	Turn-off delay time		-	30	45	ns
t_f	Turn-off fall time		-	30	45	ns
L_d	Internal drain inductance	Measured from drain lead 6 mm from package to centre of die	-	4.5	-	nH
L_s	Internal source inductance	Measured from source lead 6 mm from package to source bond pad	-	7.5	-	nH

ISOLATION $T_{hs} = 25\text{ °C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{isol}	Repetitive peak voltage from all three terminals to external heatsink	R.H. $\leq 65\%$; clean and dustfree	-	-	1500	V
C_{isol}	Capacitance from T2 to external heatsink	$f = 1\text{ MHz}$	-	12	-	pF

PowerMOS transistor

BUK442-60A/B

PHILIPS INTERNATIONAL

56E D ■ 7110826 0044566 589 ■ PHIN

REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

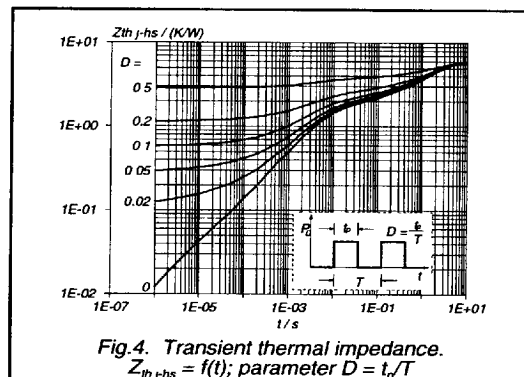
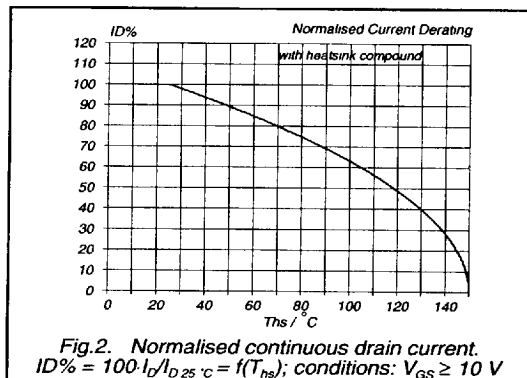
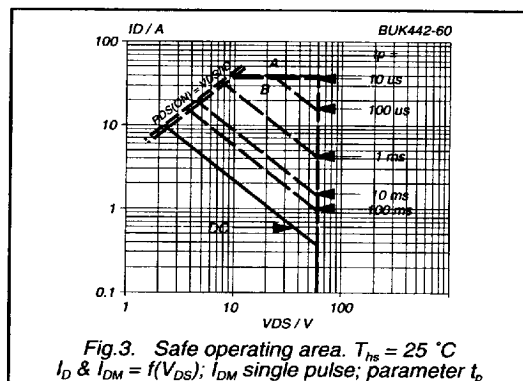
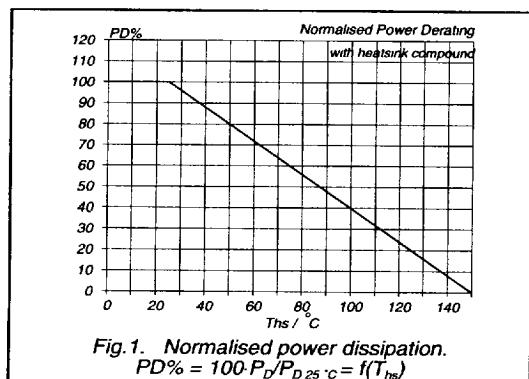
 $T_{hs} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{DR}	Continuous reverse drain current	-	-	-	10	A
I_{DRM}	Pulsed reverse drain current	-	-	-	40	A
V_{SD}	Diode forward voltage	$I_F = 10\text{ A}; V_{GS} = 0\text{ V}$	-	1.4	1.7	V
t_{rr}	Reverse recovery time	$I_F = 10\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s}; V_{GS} = 0\text{ V}; V_R = 30\text{ V}$	-	60	-	ns
Q_{rr}	Reverse recovery charge	$V_{GS} = 0\text{ V}; V_R = 30\text{ V}$	-	0.15	-	μC

AVALANCHE LIMITING VALUE

 $T_{hs} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
W_{DSS}	Drain-source non-repetitive unclamped inductive turn-off energy	$I_D = 15\text{ A}; V_{DD} \leq 30\text{ V}; V_{GS} = 10\text{ V}; R_{GS} = 50\text{ }\Omega$	-	-	30	mJ



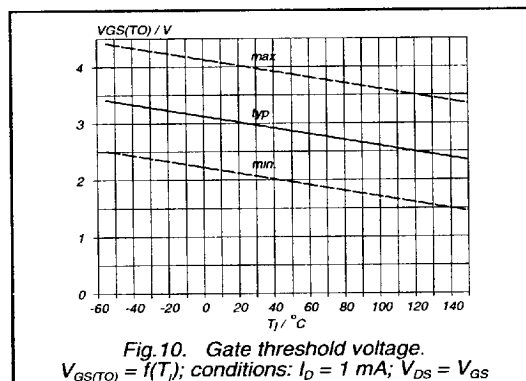
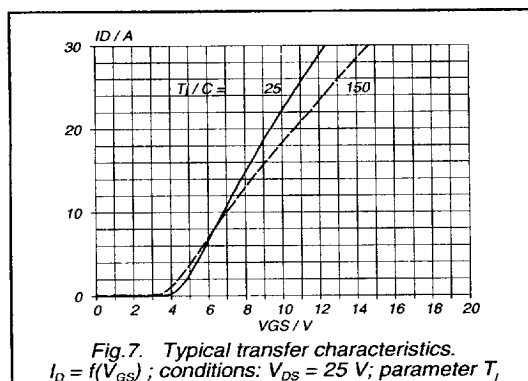
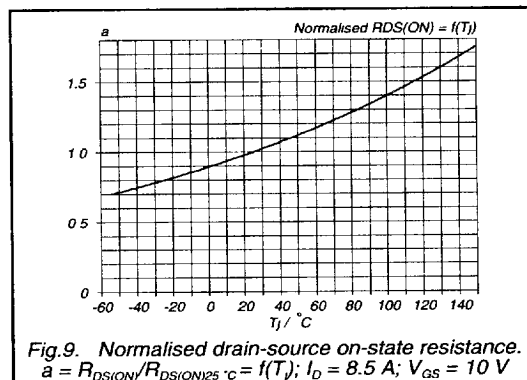
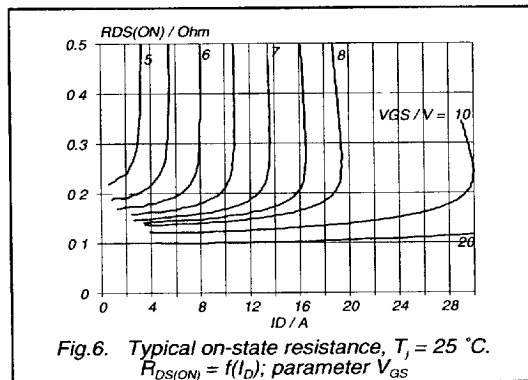
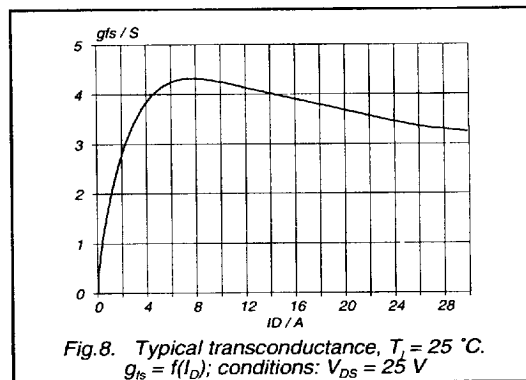
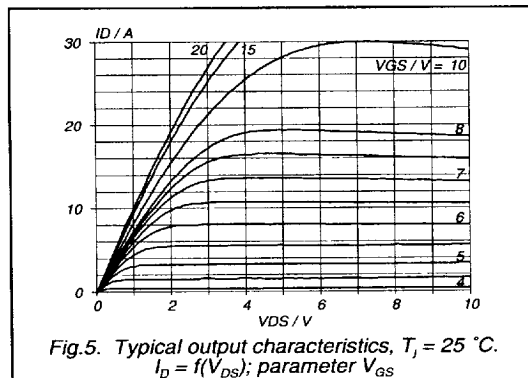
PowerMOS transistor

BUK442-60A/B

PHILIPS INTERNATIONAL

56E D

7110826 0044567 415 PHIN



PowerMOS transistor

BUK442-60A/B

PHILIPS INTERNATIONAL

56E D ■ 7110826 0044568 351 ■ PHIN

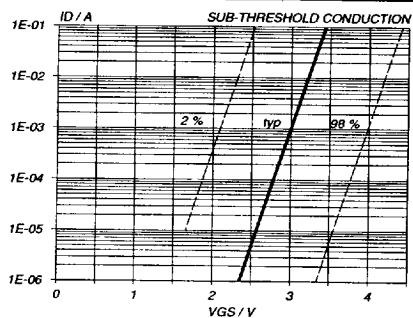


Fig. 11. Sub-threshold drain current.
 $I_D = f(V_{GS})$; conditions: $T_J = 25^\circ\text{C}$; $V_{DS} = V_{GS}$

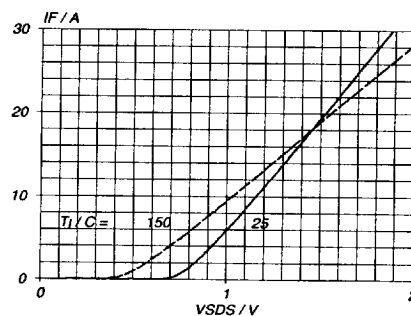


Fig. 14. Typical reverse diode current.
 $I_F = f(V_{SDS})$; conditions: $V_{GS} = 0\text{ V}$; parameter T_J

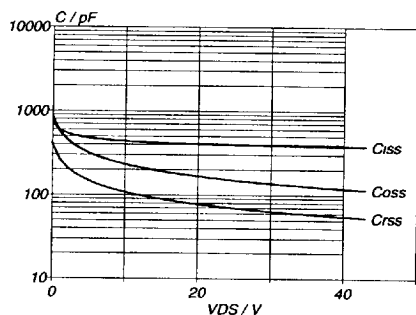


Fig. 12. Typical capacitances, C_{iss} , C_{oss} , C_{rss} .
 $C = f(V_{DS})$; conditions: $V_{GS} = 0\text{ V}$; $f = 1\text{ MHz}$

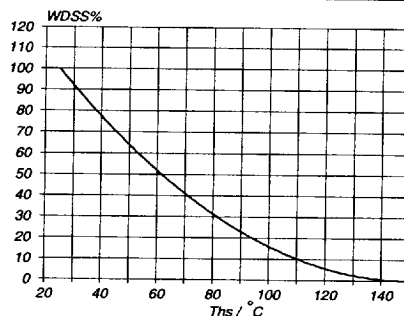


Fig. 15. Normalised avalanche energy rating.
 $W_{DSS}\% = f(T_{hs})$; conditions: $I_D = 15\text{ A}$

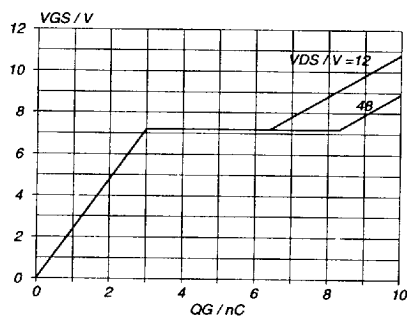


Fig. 13. Typical turn-on gate-charge characteristics.
 $V_{GS} = f(Q_G)$; conditions: $I_D = 15\text{ A}$; parameter V_{DS}

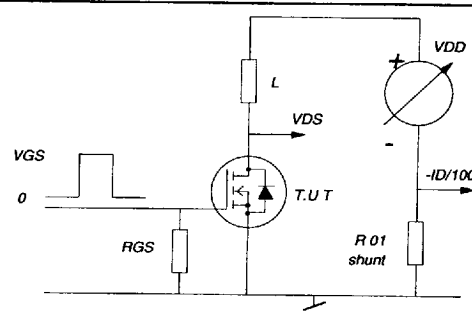


Fig. 16. Avalanche energy test circuit.
 $W_{DSS} = 0.5 \cdot L I_D^2 \cdot BV_{DSS} / (BV_{DSS} - V_{DD})$